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12  
13 UNITED STATES DISTRICT COURT  
14 NORTHERN DISTRICT OF CALIFORNIA  
SAN FRANCISCO DIVISION

15 ASETEK HOLDINGS, INC. AND ASETEK  
16 A/S,

17 Plaintiffs,

18 v.

19 COOLIT SYSTEMS INC.,

20 Defendant.

Case No. 3:12-cv-04498-EMC

**DEFENDANT COOLIT SYSTEMS,  
INC.'S NOTICE OF MOTION AND  
MOTION FOR SUMMARY  
JUDGMENT OF NON-  
INFRINGEMENT OF U.S. PAT. NOS.  
8,240,362 AND 8,245,764, NO  
DAMAGES FOR NON-U.S. SALES,  
NO LOST PROFITS, INVALIDITY OF  
U.S. PAT. NO. 8,245,764, AND  
INFRINGEMENT OF U.S. PAT. NO.  
8,382,456**

**Date:** July 24, 2014

**Time:** 1:30 pm

**Courtroom:** 5, 17<sup>th</sup> Floor

**Judge:** Hon. Edward M. Chen

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**NOTICE OF MOTION AND MOTION**

PLEASE TAKE NOTICE that Defendant CoolIT Systems, Inc. moves, pursuant to Federal Rule of Civil Procedure 56, for summary judgment of (1) non-infringement of Asetek's U.S. Pat. Nos. 8,240,362 and 8,245,764 for all accused products; (2) no damages for all sales made by CoolIT outside of the U.S.; (3) no lost profits damages; (4) invalidity of U.S. Pat. No. 8,245,764; and (5) infringement by Asetek's Gen III and Gen IV products of CoolIT's U.S. Pat. No. 8,382,456. This Motion is based on the Memorandum of Points and Authorities set forth below, the supporting declaration of Joel L. Dion ("Dion Decl.") and exhibits thereto, and such other matters as may be presented at the hearing on CoolIT's motion and allowed by the Court.

**MEMORANDUM OF POINTS AND AUTHORITIES**

**I. INTRODUCTION**

Asetek Holdings, Inc. and Asetek A/S (collectively "Asetek") sued CoolIT alleging that certain CoolIT products infringe two of Asetek's patents, U.S. Pat. Nos. 8,240,362 ("the '362 patent") and U.S. Pat. No. 8,245,764 ("the '764 patent") (collectively "the Asetek patents"). Asetek accuses CoolIT of infringement of claims 14, 15, and 17-19 of the '362 patent and claims 1-18 of the '764 patent and avers that it is entitled to lost profits as a consequence. CoolIT counterclaimed against Asetek for, *inter alia*, infringement by Asetek of CoolIT's U.S. Pat. No. 8,382, 456 ("the CoolIT Patent"). CoolIT accuses Asetek of infringing claims 17-19 of the CoolIT Patent.<sup>1</sup> Discovery is now complete and the undisputed facts demonstrate that:

- CoolIT's accused products do not infringe the Asetek patents at least because the accused products lack the claimed "reservoir," "substantially circular passage," "passage on the horizontal wall," and "fluidly coupled pump chamber and thermal exchange chamber";
- CoolIT is not liable for damages for its sales to Corsair in the ordinary course because none of the allegedly infringing conduct occurs within the United States;

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<sup>1</sup> CoolIT had, initially, accused Asetek of infringement of claims 1-19 of the CoolIT patent. After completing fact discovery, however, CoolIT withdrew its assertion of claims 1-16.

- Even if CoolIT were liable to Asetek, Asetek is not entitled to lost profits because of the availability of non-infringing alternatives;
- The '764 Patent is invalid under 35 U.S.C. §§ 102 and 103 because claims 1-19 are anticipated by or are obvious from U.S. Patent No. 7,544,049 to Koga; and
- Asetek infringes claims 17-19 of the CoolIT patent.

## **II. RELEVANT FACTS REGARDING PATENTS-IN-SUIT AND ACCUSED PRODUCTS**

### **A. Asetek's Patents and Infringement Allegations**

The Asetek patents relate generally to an improvement for a closed loop, pumped liquid cooling system for computers. *See* '764 patent, Ex. A to the Dion Decl., at col. 1, lns. 16-19; '362 patent, Ex. B to the Dion Decl., at col. 1, lns. 18-21. According to the Asetek patents, early liquid cooling solutions, while providing better cooling efficiency than the prior art systems, suffered from a number of shortcomings, including complexity, difficulty in installation, large size (which was difficult to accommodate in many computer cases), and the potential for leaks. *E.g.* '764 patent at col. 1, lns. 37-47; '362 patent at col. 1, lns. 39-49. Both Asetek patents are directed toward novel solutions to these shortcomings in the prior art systems.

Asetek has accused CoolIT's products that incorporate its ECO II and ECO III cooling heads (with the exception of certain rack-based products that use centralized pumping) of infringement. *See*, Initial Expert Report of Dr. Donald E. Tilton Regarding Infringement of U.S. Patent Nos. 8,240,362 and 8,245,764 ("Tilton Infringement Report"), attached as Ex. C to the Dion Decl. For purposes of this litigation, the parties have stipulated that, relative to the Asetek patents' claims, the ECO II and ECO III products are identical. D.E.# 169.

### **B. CoolIT's Patent and Infringement Allegations**

CoolIT's patent is also directed, generally, to an improvement for a closed loop, pumped liquid cooling system. *See* CoolIT patent, attached as Ex. D to the Dion Decl. The CoolIT patent describes and claims one way to accommodate fluid expansion that occurs within these systems through the use of a resiliently compressible member, such as closed cell foam. *Id.* at col. 3, lns. 23-25.

CoolIT has accused Asetek's products that incorporate its Gen III and Gen IV cooling heads of infringement. *See* Expert Report of Dr. Himanshu Pokharna Regarding Infringement of CoolIT's U.S. Pat. No. 8,382,456 ("Pokharna Infringement Report")<sup>2</sup>, attached as Ex. E to the Dion Decl.

### III. LEGAL STANDARD FOR SUMMARY JUDGMENT

CoolIT is entitled to summary judgment if it can show that there are no disputes of material fact and it is entitled to judgment as matter of law. Fed. R. Civ. P. 56. To evaluate claims of patent infringement, the Court first construes the claims as a matter of law and then compares the claims as construed to the accused device(s). *See Bayer AG v. Elan Pharm. Research Corp.*, 212 F.3d 1241, 1247 (Fed. Cir. 2000). The absence of even a single claim limitation precludes a finding of infringement. *Telemac Cellular Corp. v. Topp Telecom, Inc.*, 247 F.3d 1316, 1330 (Fed. Cir. 2001). To prove infringement, the proponent bears the burden of proving that the accused products meet each element of each asserted claim. *Bayer*, 212 F.3d at 1247. With respect to summary judgment of non-infringement, "nothing more is required than the filing of a summary judgment motion stating that the patentee had no evidence of infringement and pointing to the specific ways in which accused systems did not meet the claim limitations." *Exigent Tech., Inc. v. Atrana Solutions, Inc.*, 442 F.3d 1301, 1309 (Fed. Cir. 2006). This case presents a particularly compelling case for summary judgment because there is no material disagreement between parties (or their respective experts) about how the accused products operate. The facts required to establish CoolIT's entitlement to summary judgment of both non-infringement of Asetek's patents and infringement of CoolIT's patent were readily admitted or are implicitly acknowledged by Asetek's own expert. The Federal Circuit has repeatedly emphasized that such a case is particularly suited to summary judgment. *See, e.g., MyMail, Ltd. v. Am. Online, Inc.*, 476 F.3d 1372, 1378 (Fed. Cir. 2007). Similarly, with regard to CoolIT's other bases for summary judgment, the facts are not in dispute. All that remains is for

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<sup>2</sup> At the Asetek 30(b)(6) deposition, the witness misidentified certain Asetek products, resulting in the inclusion of Asetek's Gen II, Gen III, and Gen IV products in Dr. Pokharna's report. The parties have resolved the confusion and agree that the Gen III and Gen IV products are at issue here.



the Court to assess the legal impact of those undisputed facts.

#### IV. COOLIT'S PRODUCTS DO NOT INFRINGE THE ASETEK PATENTS

CoolIT's products do not infringe any of the asserted claims of the Asetek patents as they have been interpreted by the Court. CoolIT's products do not infringe any asserted claims of the '362 patent at least because the accused products lack the claimed "reservoir," "substantially circular passages," and passages that are "on the horizontal wall." CoolIT's products do not infringe any asserted claims of the '764 Patent at least because the accused products lack the claimed "reservoir" and "fluidly coupled pump chamber and thermal exchange chamber".

##### A. CoolIT's Products Do Not Infringe Asetek's '362 Patent.

##### 1. CoolIT's Products Lack a "Reservoir" (Claims 14, 15, and 17-19)

The Court concluded that the dictionary definition for "reservoir," "a receptacle or chamber for holding a liquid or fluid," best captures the meaning of the term based on the language of Asetek's patents. D.E.# 155. CoolIT's accused products do not include a receptacle or chamber for *holding* a liquid or fluid. The term "holding," particularly in the context of a reservoir, connotes holding in the sense of storing something. This is not what the supposed "reservoir" identified in the accused CoolIT products does. According to CoolIT's expert, "I would not call the flow passages between a pump means to be a reservoir because it's not really holding a liquid. It's continuously flowing all throughout." Transcript of June 3, 2014 Deposition of Dr. Himanshu Pokharna ("Pokharna Tr."), attached as Ex. F to the Dion Decl., at 70. No portion of the CoolIT pump head is "holding" the liquid. Instead, during the operation of the CoolIT device, the liquid continuously flows through all the fluid chambers and passageways within the pump head and, in that sense, there is no reservoir. In fact, the volume of fluid in the *radiator* of the accused CoolIT products is an order of magnitude larger than that in the pump head. *See* Rebuttal Expert Report of Dr. Himanshu Pokharna Regarding Non-Infringement of Asetek's U.S. Patent Nos. 8,240,362 and 8,245,764 at 5, attached as Ex. G to the Dion Decl. ("Pokharna Non-Infringement Rebuttal"). Therefore, if any part of CoolIT's products can be said to act as a reservoir, i.e. a place for holding or storing the cooling liquid, the radiator is performing the function of a reservoir, not the pump head, where no liquid is held during

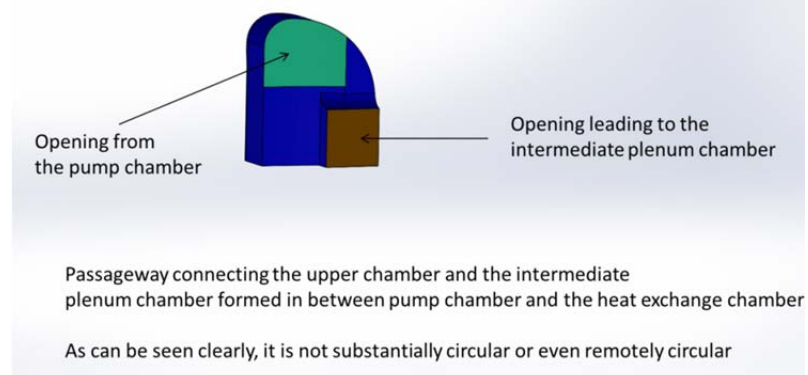
operation of the products. The area referred to as “reservoir” in all the figures of the Tilton Infringement report can reasonably be termed as a flow passage, but not a “reservoir” as construed by the Court. As a result, CoolIT’s accused products do not infringe claims 14, 15, or 17-19 of the ‘362 patent.

**2. CoolIT’s Products Lack a Substantially Circular Passageway (Claims 14-15) and the Passageway Is Not on the Horizontal Wall (Claims 14-15 and 17-19)**

The upper chamber and lower chamber of CoolIT’s accused products are not “fluidly coupled by one or more passageways, at least one of the one or more passageways being positioned on the horizontal wall.” The Court specified in its December 3, 2013 Order that “[w]here the means of connection are specified, the Court concludes that that is the exclusive means by which the coupling can be accomplished. Thus, for claim 1 of the ‘362 patent, the chambers must only be connected by a plurality of substantially circular passages and nothing more.” D.E.# 155 at 10.

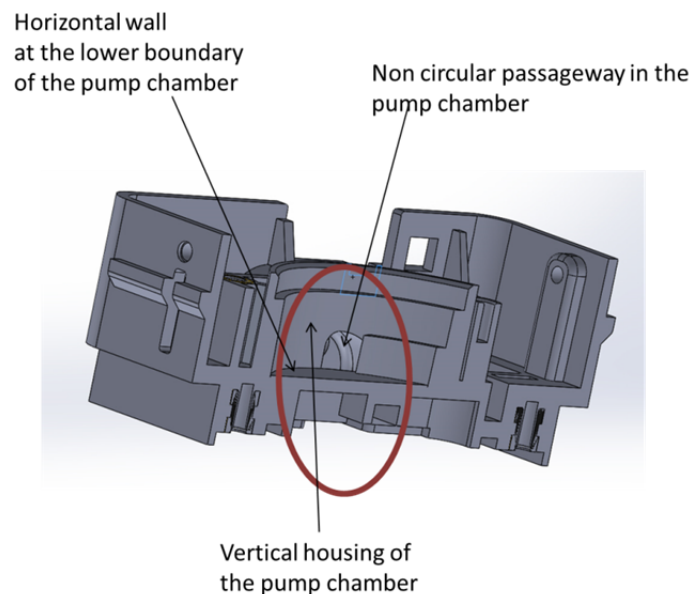
In CoolIT’s accused products, the upper and the lower chambers of the accused products are fluidly connected via a single passageway. However, the passageway is not substantially circular and is not on the horizontal wall separating the two chambers.

The passageway in the CoolIT products is not at all circular. The decision to make the channel non-circular was intentional and highly functional. Within the spatial constraints of CoolIT’s design, use of a substantially rectangular shape created a far larger opening than a circular opening would in the same space. As can be seen from the CAD files for the CoolIT accused products, the passageway that connects the upper and lower chamber is amorphous, not substantially circular:



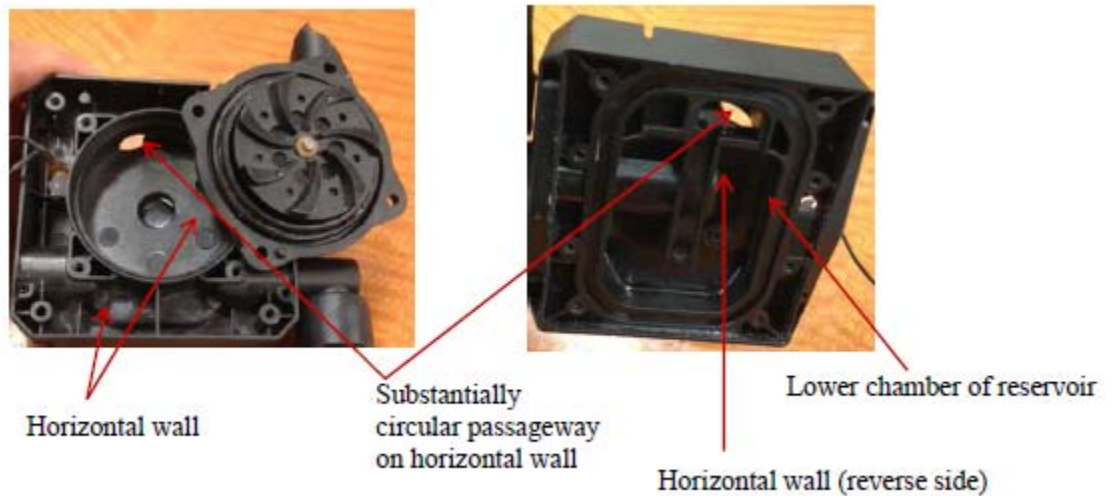
Pokharna Non-Infringement Rebuttal at Ex. B, Fig. 2. At his deposition, Asetek's expert, Dr. Tilton, testified that he believes that passageway is circular because it has rounded corners and/or edges. Transcript of June 9, 2014 Deposition of Dr. Donald Tilton ("Tilton Tr."), attached as Ex. H to the Dion Decl., 81:2-8. This tortured argument is simply not credible and makes a mockery of the plain English in the claim.

Moreover, CoolIT's fluid passageway extends from the vertical part of the upper passageway housing and not the horizontal wall separating the upper and the lower passageways. The Tilton Expert Report appears to identify the entire horizontal portion of the pump head as the "horizontal wall," presumably to support the argument that the passageway is "on" the horizontal wall. This is not the "horizontal wall" as specified by the '362 patent. The '362 patent claims specify that the "horizontal wall" is the wall vertically separating the upper and the lower chambers in the pump head. In the CoolIT accused products, to the extent there is a "horizontal wall" separating the two chambers, it ends at the end of the circular pump volute. The passageway, however, starts just beyond the alleged "horizontal wall," on the vertical wall of the pump volute:



As can be clearly seen, the non-circular passageway is formed on the vertical housing of the pump chamber and not the horizontal wall

Pokharna Non-Infringement Rebuttal at Ex. B, Fig. 1.



Tilton Infringement Report at Ex. B, pg. 2

In fact, during his deposition, Dr. Tilton retreated from the position in his report and testified that the supposed “reservoir” was only the portions of the cooling head that hold liquid, Tilton Tr. at 74:21-77:3, confirming that the horizontal wall stops at the vertical wall where the passageway starts. The passageway extending from the pump chamber/upper chamber in CoolIT’s products is not on the horizontal wall, but is formed in the vertical section of the housing for the pump/upper chamber and not the horizontal wall separating the upper and lower chambers.

### 3. CoolIT’s Products Lack an Impeller Whose Speed Is Configured to Be Varied (Claims 14-15)

CoolIT’s accused products do not have an impeller whose speed is configured to be varied. The speed of the fans can be varied in some CoolIT products, such as the H60. However, the pump in CoolIT’s products operates at a constant speed (in revolutions per minute) and, therefore, the impeller is independent of the fan but its speed is not configured to be varied, as required in Claim 14 of the ‘362 patent. Therefore, CoolIT’s products do not infringe Claim 14 of the ‘362 patent. See Pokharna Non-Infringement Rebuttal at 7. Dr. Tilton suggests that the impeller speed can be varied by varying the current supplied to the pump by the motherboard. Tilton Tr. at 101:22-102:10. Even if true, this does not result in a product with an “impeller

1 whose speed is configured to be varied.” Rather, this reaffirms that the impeller speed is  
2 configured to be constant, depending on the current supplied by the system.

3 **B. CoolIT’s Products Do Not Infringe Asetek’s ‘764 Patent.**

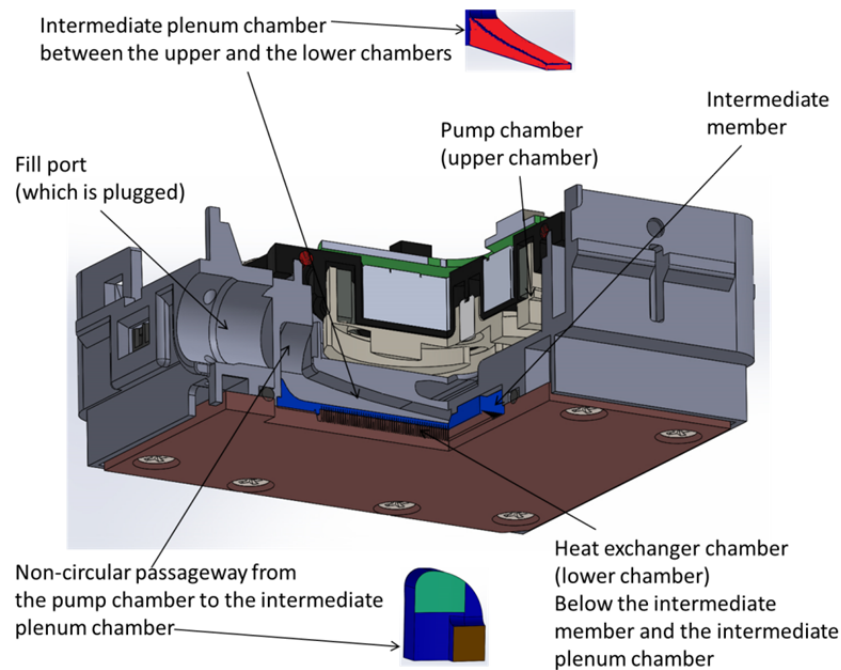
4 **1. CoolIT’s Products Lack a “Reservoir” (Claims 1-18)**

5 The Court construed the term “reservoir” identically for both the ‘362 patent and the ‘764  
6 patent. Accordingly, for the same reasons that CoolIT’s products do not infringe the “reservoir”  
7 limitation of the ‘362 patent, they do not infringe the “reservoir” limitation of the ‘764 patent.

8 **2. CoolIT’s Products Lack Direct Fluid Coupling between the Pump  
Chamber and the Thermal Exchange Chamber (Claims 1-18).**

9 The upper chamber and lower chamber of CoolIT’s accused products are not “fluidly  
10 coupled” or “coupled” as that term has been interpreted by the Court because there is an  
11 intervening component in CoolIT’s accused products. The Court specified in its December 3,  
12 2013 Order that “[w]here the means of connection are specified, the Court concludes that that is  
13 the exclusive means by which the coupling can be accomplished.” D.E.# 155 at 10. Asetek’s  
14 expert seems to conveniently ignore the Court’s instruction that “[t]he parties, however, should be  
15 mindful of the Court’s ruling here that, where a means of coupling is specified, that is the  
16 exclusive means of connection.” *Id.* at 12.

17 All of the accused CoolIT products lack a direct fluid passage joining the pump chamber  
18 to the heat exchange chamber. Instead, these products use an intermediate member, which forms  
19 an intermediate chamber vertically displaced from the pump chamber and also vertically  
20 displaced from the thermal exchange chamber. This intermediate chamber is sandwiched  
21 between the pump chamber and the thermal exchange chamber:  
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25  
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Pokharna Non-Infringement Rebuttal at Ex. B, Fig. 5.

The intermediate chamber serves two critical roles in the CoolIT pump head design. Pokharna Non-Infringement Rebuttal at 9. First, the intermediate plenum chamber provides the role of a plenum and ensures that the coolant can be substantially uniformly distributed in all the channels formed by the fins on the inside of the heat exchange interface. *Id.* Second, this intermediate plenum chamber is formed substantially in the center of the fins such that the cold coolant can enter the heat exchange chamber at the center of the CPU where the CPU temperature is the likely to be highest, which is important to cooling efficiency. *Id.*

Fluid from the pump chamber exits via the non-circular passageway on the vertical housing of the pump chamber and enters the intermediate plenum chamber formed between the top of the intermediate member and the impeller housing. *Id.* From the intermediate plenum chamber the fluid enters the thermal exchange chamber. Therefore, there is no fluid coupling between the pump chamber and the thermal exchange chamber (as constructed by court, the Claim 1 of the '764 patent specifies direct fluid coupling between the pump chamber and the thermal exchange chamber, which is not the case here). *Id.* At his deposition, Dr. Tilton admitted that this intermediate area was a "chamber" as that term is used in the '764 patent. Tilton Tr. at 95:21-100:19.



Similarly, claim 15 of the '764 Patent, despite calling for an intermediate member, still claims an arrangement with "the pump chamber and the thermal exchange being spaced apart from each other in a vertical direction and fluidly coupled together." '764 patent at claim 15. However, in the CoolIT designs, there is an additional chamber that is formed between the intermediate member and the pump impeller, described by Dr. Pokharna as the intermediate plenum chamber. Pokharna Non-Infringement Rebuttal at 9. The fluid coupling in the CoolIT accused devices is between the intermediate plenum chamber and the pump chamber, and between the intermediate plenum chamber and the heat exchange chamber, but not directly between the heat exchange chamber and the pump chamber, as required by claim 15 of the '764 patent. Accordingly, the accused CoolIT products do not infringe any of the asserted claims of the '764 patent.

**V. EVEN IF COOLIT'S PRODUCTS DID INFRINGE, COOLIT'S SALES OF ALLEGEDLY INFRINGING PRODUCTS TO CORSAIR (HONG KONG), A FOREIGN COMPANY, ON FOREIGN SOIL ARE NOT INFRINGING AS A MATTER OF LAW**

Even if CoolIT's accused products did infringe the Asetek patents, CoolIT is not liable to Asetek for damages for its sales to Corsair in the normal course of business<sup>3</sup> because none of the allegedly infringing conduct in connection with the normal course of Corsair sales occurs within the United States. The products sold by CoolIT, a Canadian company, to Corsair (Hong Kong) Ltd. are sold to a Hong Kong entity, paid for by a Hong Kong entity, and delivered to a Hong Kong entity in Hong Kong. Accordingly, CoolIT does not take any action in connection with its sales to Corsair within the United States.

As a general rule, a U.S. patent does not have extraterritorial effect; activities must occur within the United States to give rise to a claim of infringement under 35 U.S.C. § 271. 35 U.S.C. § 271(a), which governs patent infringement, provides: "whoever without authority makes, uses,

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<sup>3</sup> It is possible that a limited number of transactions between CoolIT and Corsair did not follow the normal course described herein. Even if that is true, however, it does not prevent entry of summary judgment. The potential factual issue of whether a limited number of transactions deviated from the norm does not prevent the Court from ruling on the purely legal issue of whether a U.S. patent has sufficient extraterritorial reach to affect a transaction between two foreign countries that occurs outside of the United States.

1 offers to sell, or sells any patented invention, within the United States or imports into the United  
 2 States any patented invention during the term of the patent therefore, infringes the patent.”

3 The “Federal Circuit made it unequivocally clear that the patent laws do not prohibit  
 4 infringement abroad and therefore do not provide ‘damages adequate to compensate’ for such  
 5 infringement.” *Fr. Telecom S.A. v. Marvell Semiconductor Inc.*, 2014 U.S. Dist. LEXIS 52564,  
 6 \*50-51 (N.D. Cal. Apr. 14, 2014) (Orrick, J.) (citing *Power Integrations, Inc. v. Fairchild*  
 7 *Semiconductor Int’l, Inc.*, 711 F.3d 1348, 1371 (Fed. Cir. 2013)). As the Supreme Court has  
 8 stated, the “traditional understanding that our patent law operates only domestically and does not  
 9 extend to foreign activities is embedded in the Patent Act itself . . . . In short, foreign law alone,  
 10 not United States law, currently governs the manufacture and sale of components of patented  
 11 inventions in foreign countries.” *Microsoft Corp. v. AT&T Corp.*, 550 U.S. 437, 455-56 (U.S.  
 12 2007) (citation and internal punctuation omitted). In *Power Integrations*, the Federal Circuit  
 13 noted that the defendant had “not cited any case law that supports an award of damages for sales  
 14 consummated in foreign markets, **regardless of any connection to infringing activity in the**  
 15 **United States.**” 711 F.3d at 1371 (emphasis added). This is so because “the entirely  
 16 extraterritorial production, use, or sale of an invention patented in the United States is an  
 17 independent, intervening act that, under almost all circumstances, cuts off the chain of causation  
 18 initiated by an act of domestic infringement.” *Id.* at 1371-72. This holds true even for products  
 19 that ultimately end up in the United States. *See Fr. Telecom S.A.*, 2014 U.S. Dist. LEXIS 52564,  
 20 at \*56-8.

21 In this case, CoolIT’s sales to Corsair involve activities conducted outside the U.S. The  
 22 Product Purchase Agreement is between CoolIT, a foreign company based in Calgary, Canada,  
 23 and Corsair Hong Kong, a foreign company based in Hong Kong. Decl. of Geoffrey S. Lyon in  
 24 Supp. of Def.’s Mot. to Dismiss (“Lyon Decl.”), ¶3 & Ex. A, ECF No. 23, attached as Ex. I to the  
 25 Dion Decl. Pursuant to the Agreement, Corsair Hong Kong issues purchase orders to CoolIT. *Id.*  
 26 at ¶4 & Ex. B. After receiving a purchase order, CoolIT delivers the H60, H80, and H100  
 27 products to Corsair Hong Kong on the terms of Free Alongside Ship (“FAS”), at which point title  
 28 transfers to Corsair Hong Kong. *Id.* ¶5 & Ex. B; *see ImEx Trading Co. v. The Vessel, Beate*



1 *Oldendorff*, 841 F. Supp. 1151, 1152 (M.D. Fla. 1993) (under FAS terms, title passes upon  
 2 delivery to the dock). Upon delivery, CoolIT issues an invoice to Corsair Hong Kong and Corsair  
 3 Hong Kong pays CoolIT for the delivered products. Lyon Decl. at ¶5. No part of the transaction  
 4 takes place in the United States. This course of conduct was confirmed by Corsair’s CEO, Andy  
 5 Paul. Transcript of April 2, 2014 Deposition of Andy Paul (“Paul Tr.”), attached as Ex. J to the  
 6 Dion. Decl., at 165:10-15; 241:1-247:3; 256:19-261:12; 294:7-296:8. In fact, Mr. Paul confirmed  
 7 that this arrangement, which Corsair insists on with all of its vendors, was set up by Corsair in  
 8 conjunction with its corporate restructuring and for Corsair’s own benefit. *Id.* at 130:7-11.

9 In *MEMC Elec. Mat’ls, Inc. v. Mitsubishi Mat’ls Silicon Corp.*, 420 F.3d 1369 (Fed. Cir.  
 10 2005), the Federal Circuit considered very similar circumstances and determined that a sale  
 11 between two foreign entities, where title transferred in Japan, could not constitute infringement as  
 12 a matter of law, even though the seller knew that the foreign purchaser sent the accused products  
 13 to its American affiliate in Texas and even where the seller communicated directly with the  
 14 American affiliate regarding the sales. *MEMC*, 420 F.3d at 1376-77.

15 Where, as here, a foreign company sells allegedly infringing products to another foreign  
 16 company, on foreign soil, those acts do not support a claim of infringement, even if the seller  
 17 knows that some of the product will ultimately be imported into the United States. *Id.* at 1377  
 18 citing *Rotec Indus. Inc. v. Mitsubishi Corp.*, 215 F.3d 1246, 1251 (Fed. Cir. 2000). In fact,  
 19 regardless of any activity that may have occurred between CoolIT and Corsair in the U.S., the  
 20 ultimate production, use, and sale of the products outside of the U.S. “is an independent,  
 21 intervening act that...cuts off the chain of causation,” *Power Integrations*, 711 F.3d at 1371-72,  
 22 and precludes liability. Just as in *MEMC*, *Power Integrations*, and *Fr. Telecom*, the Court cannot  
 23 extend the extraterritorial reach of Asetek’s patents to implicate CoolIT’s entirely ex-U.S.  
 24 conduct, as Asetek invites the Court to do. Accordingly, Asetek cannot claim damages for  
 25 CoolIT’s sales to Asetek outside of the U.S. and summary judgment in CoolIT’s favor is  
 26 appropriate.

1 **VI. ASETEK IS NOT ENTITLED TO LOST PROFITS**

2 There is no genuine dispute that Asetek's claim for recovery of lost profits does not meet  
3 the *Panduit* test at least because there were and are acceptable non-infringing alternatives to the  
4 Asetek patents available. As a result, Asetek, at most, would be entitled only to a reasonable  
5 royalty if the Court or jury were to determine that CoolIT's products infringe Asetek's patents.

6 **A. The *Panduit* Standard and Its Progeny**

7 "To recover lost profits damages, the patentee must show a reasonable probability that,  
8 'but for' the infringement, [the patentee] would have made the sales that were made by the  
9 infringer." *Rite-Hite Corp. v. Kelley Co.*, 56 F.3d 1538, 1545 (Fed. Cir. 1995) (en banc). The  
10 Court of Appeals for the Sixth Circuit in *Panduit Corp. v. Stahl Bros. Fibre Works, Inc.*  
11 articulated the following four factors that the patentee must establish to satisfy the lost profits  
12 causation requirement (known as the "*Panduit* Test"): "(1) demand for the patented product, (2)  
13 absence of acceptable noninfringing substitutes, (3) his manufacturing and marketing capability  
14 to exploit the demand, and (4) the amount of the profit he would have made." 575 F.2d 1152,  
15 1156 (6th Cir. 1978). The *Panduit* Test "has [] been accepted as a useful, but non-exclusive, way  
16 for a patentee to prove entitlement to lost profits damages." *Rite-Hite*, 56 F.3d at 1545.

17 Under the second factor of the *Panduit* Test, the patentee must show that there is an  
18 "absence of acceptable noninfringing substitutes." *Panduit*, 575 F.2d at 1156. Thus, "acceptable  
19 substitutes that the infringer proves were available during the accounting period [*i.e.*, 'the period  
20 of infringement for which the patent owner claims damages'] can preclude or limit lost profits."  
21 *Grain Processing Corp. v. Am. Maize-Prods. Co.*, 185 F.3d 1341, 1353 (Fed. Cir. 1999).

22 Addressing whether a noninfringing alternative product is "acceptable," the Court of  
23 Appeals for the Federal Circuit in *Grain Processing* wrote, "[w]hether and to what extent [the  
24 infringer's] alleged alternative prevents [the patentee] from showing lost sales of [its infringed  
25 product] depends . . . on whether and to what extent it was acceptable as a substitute in the  
26 relevant market." *Id.* at 1355. The court continued:

27 Consumer demand defines the relevant market and relative  
28 substitutability among products therein. Important factors shaping  
demand may include consumers' intended use for the patentee's

1 product, similarity of physical and functional attributes of the  
2 patentee's product to alleged competing products, and price. Where  
3 the alleged substitute differs from the patentee's product in one or  
4 more of these respects, the patentee often must adduce economic  
data supporting its theory of the relevant market in order to show  
'but for' causation.

5 *Id.* (internal citations omitted); *see also Linear Tech. Corp. v. Micrel, Inc.*, 2006 U.S. Dist. LEXIS  
6 96860, at \*116-17 (N.D.Ca. June 9, 2006) (finding defendant's proffered noninfringing  
7 alternative, produced three years after the infringement period commenced, to be acceptable  
8 based on its "functional similarity" to the infringing device "despite the small loss in efficiency of  
9 the re-designed parts," and that defendant's "customers either did not notice or did not care that  
10 their devices had been changed").

11 With respect to whether a proposed noninfringing alternative is "available," in addition to  
12 products that are "actually 'on sale' during the infringement period" (which are, of course,  
13 "available"), even a product that was "not on the market at the time of infringement can, in  
14 certain circumstances, constitute an available, noninfringing alternative." *Micro Chem. v.*  
15 *Lextron, Inc.*, 318 F.3d 1119, 1122 (Fed. Cir. 2003) (citing *Grain Processing*, 185 F.3d at 1351-  
16 52).

17 In *Grain Processing*, the court concluded that the defendant's proffered noninfringing  
18 alternative was "available" throughout the accounting period, *id.* at 1354, by "weigh[ing] the  
19 factors that would show the substitute's effect on the market." *Micro Chem.*, 318 F.3d at 1123  
20 (citing *Grain Processing*, 185 F.3d at 1346). Such factors included the availability of the  
21 requisite materials, equipment, knowledge, and experience, as well as considerations of time and  
22 cost. *See Grain Processing*, 185 F.3d at 1354. Specifically, the defendant in *Grain Processing*  
23 "could readily obtain all of the materials needed" and "had all of the necessary equipment, know-  
24 how, and experience" for the alleged substitute. *Id.* The court also considered cost as a factor,  
25 noting that "the high cost of a necessary material can conceivably render a substitute  
26 'unavailable,'" though the necessary material in *Grain Processing* "was not prohibitively  
27 expensive to [the defendant]" based on the fact that its "'substantial profit margins' . . . were  
28 sufficient for it to absorb the 2.3% cost increase" using such material. *Id.*

**B. Application of *Panduit* – No Lost Profits for Asetek**

It is impossible for Asetek to meet the *Panduit* lost profits causation requirements. Most significantly, Asetek cannot establish an absence of acceptable non-infringing substitutes because other configurations of the cooling systems are possible. Asetek's Chief Executive Officer admitted this fact. *See* Transcript of April 8, 2014 Deposition of Andre Eriksen ("Eriksen Tr."), attached as Ex. K to the Dion Decl., at 77:14-88:4. CoolIT has used alternative, non-infringing, designs in the past, designs that Asetek concedes do not infringe. CoolIT could have reverted to its prior designs. And, by adapting its newest cold plate design to use in its prior, non-infringing design, CoolIT could have achieved the same cooling efficiency as in its newer product. Again, Asetek admits this fact and agrees that the cold plate is the critical element for the systems efficiency:

Q. Do you think, if you took the Generation [4]<sup>4</sup> cold plate and developed that system that had that cold plate separated from pump, from a thermal performance standpoint, do you think they would perform similarly?

\* \* \*

A. I think the way to characterize it is if you make sure the liquid flow to the cold plate was the same, then the performance of the cold plate would also be the same.

Eriksen Tr. at 68:13-23. This combination of the new cold plate and old pump design would have been acceptable to Corsair, so long as it had sufficient thermal efficiency. Mr. Eriksen confirmed that the supposed benefit of the Asetek patents is not on Corsair radar when it is specifying products. Rather, Corsair cares about the appearance of the product, the thermal performance, and the cost. *Id.* at 123:25-124:25.

Finally, CoolIT would have undoubtedly had sufficient resources, know-how, and time to implement this alternative design. First, the two key components – the system design and cold plate design – already existed. Second, CoolIT would have more than enough time to implement this design, including the time from when the patents issued through January 2013, when

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<sup>4</sup> At his deposition, Mr. Eriksen confused Asetek's Gen III and Gen IV products. Thus, references to Gen III should be to Asetek's Gen IV design.

1 CoolIT's sales to Corsair were covered by Asetek's license with Corsair. *See* D.E.# 194.  
 2 Because at least one acceptable non-infringing alternative was available, Asetek cannot recover  
 3 lost profits, even if CoolIT is liable for patent infringement.

#### 4 **VII. THE '764 PATENT IS INVALID**

5 Asetek's '764 Patent is invalid under 35 U.S.C. §§ 102 and 103 because claims 1-19 are  
 6 anticipated by or are obvious from U.S. Patent No. 7,544,049 to Koga, published on December 2,  
 7 2004, and issued on June 9, 2009 ("Koga").<sup>5</sup> *See* Expert Report of Dr. Himanshu Pokharna  
 8 Regarding the Invalidity of Asetek's U.S. Patent Nos. 8,240,362 and 8,245,764 ("Pokharna  
 9 Invalidity Report"), pp. 65-85, attached as Ex. L to the Dion Decl. Contrary to the arguments  
 10 made in Dr. Tilton's report, the Koga Patent discloses each and every claim in Asetek's '764  
 11 Patent.

12 Starting with claim 1, Dr. Tilton states that "at least the limitation 'a heat-exchanging  
 13 interface, the heat-exchanging interface forming a boundary wall of the thermal exchange  
 14 chamber, and configured to be placed in thermal contact with a surface of the heat-generating  
 15 component,' recited in claim 1, is not disclosed or suggested by Koga." However, Dr. Tilton's  
 16 assertion is factually inaccurate because Koga's heat generating component 2 forms a boundary  
 17 wall of sucking channel 19 and transverse section 30, which together function as a thermal  
 18 exchange chamber. Dr. Tilton makes the unfounded assumption that there can be only one  
 19 thermal exchange chamber in a cooling device, which is erroneous. By any functional definition,  
 20 Koga's sucking channel 19 and transverse section 30 act as a thermal exchange chamber because  
 21 heat transfers by contact from the heat generating component 2 to the outside wall of the sucking  
 22 channel 19, which carries coolant 41; through this subsystem, Koga's sucking channel 19 and  
 23 transverse section 30 accept heat from the heat generating component 2. In other words, Koga's  
 24 pump room 15A is not the sole and exclusive heat exchange chamber of the Koga patent.

25  
 26  
 27 <sup>5</sup> CoolIT notes that the United States Patent and Trademark Office already has issued an Action  
 28 Closing Prosecution determining all claims of the '764 patent to be invalid in a pending  
 reexamination before the Patent Trial and Appeal Board. Issuance of a Right of Appeal Notice by  
 the Patent Trial and Appeal Board is expected shortly.

1 By arguing solely against one limitation of claim 1, Dr. Tilton implicitly admits that Koga  
2 discloses the remaining limitations of claim 1.

3 Dr. Tilton relies on the fact that claims 2-3 and 6-9 depend from claim 1 as the reason why  
4 claims 2-3 and 6-9 are not anticipated or rendered obvious by Koga. By relying solely on the  
5 dependence from claim 1, Dr. Tilton implicitly admits that the remaining limitations of these  
6 claims are anticipated or rendered obvious by Koga.

7 Dr. Tilton disputes Dr. Pokharna's explanation of the way in which Koga exactly  
8 discloses claim 4 ("The cooling system of claim 3, wherein the first side of the heat-exchanging  
9 interface includes features that are adapted to increase heat transfer from the heat-exchanging  
10 interface to the cooling liquid in the thermal exchange.") Dr. Pokharna explains in his expert  
11 report that Koga's inner surface of the casing 15 includes features adapted to increase heat  
12 transfer from the casing 15 to the coolant. Dr. Tilton attempts to argue that Dr. Pokharna  
13 incorrectly interpreted "sucking channel 19" and "transverse section 30" as the "thermal  
14 exchange chamber" of the '764 Patent, *see, e.g.*, Expert Report of Dr. Donald E. Tilton Regarding  
15 Validity of U.S. Patent Nos. 8,240,362 and 8,245,764 ("Tilton Validity Report"), at 25, attached  
16 as Ex. M to the Dion Decl., but these arguments are an attempt to distract from the actual  
17 functionality and meaning of the specification of Koga by means of the differing terminology  
18 used in Koga and the '764 Patent. The sucking channel 19 and transverse section 30 of Koga  
19 function as a thermal exchange chamber in that heat is transferred by direct contact from the heat  
20 generating component 2 to the sucking channel 19 and transverse section 30. Pokharna Tr. at  
21 366:5-8. The pump room 15A is not the sole and exclusive heat exchange chamber of the Koga  
22 patent – the sucking channel 19 and transverse section 30 are also a heat exchange chamber.

23 Dr. Tilton relies on the fact that claim 5 depends from claim 4 as the reason why claim 5  
24 is not anticipated or rendered obvious by Koga. By relying solely on dependence from claim 4,  
25 Dr. Tilton implicitly admits that the limitations of claim 5, ". . . at least one of pins or fins," are  
26 anticipated or rendered obvious by Koga. In other words, Dr. Tilton admits that the dimples 21  
27 and/or protrusions 24 of the Koga patent disclose the pins or fins of claim 5 of the '764 Patent.  
28

1 As for claim 10, Dr. Tilton states that the following limitations of the '764 Patent are not  
2 disclosed or suggested by Koga: (1) "a thermal exchange chamber adapted to be positioned in  
3 thermal contact with the heat-generating component"; and (2) "a separate pump chamber  
4 vertically spaced part from the thermal exchange chamber and coupled with the thermal exchange  
5 chamber through one or more passages configured for fluid communication between the pump  
6 chamber and the thermal exchange chamber." Dr. Tilton incorrectly states that "Koga fails to  
7 disclose a 'pump chamber' separate from the 'thermal exchange chamber'" – Koga's sucking  
8 channel 19 and transverse section 30 perform the function of a thermal exchange chamber despite  
9 the difference in terminology because heat is transferred through direct contact between the heat  
10 generating component 2 and the sucking channel 19 and transverse section 30. Further, Dr.  
11 Tilton is wrong to assert that Koga's sucking channel 19 and transverse section 30, which  
12 together constitute a "thermal exchange chamber," are not placed in thermal contact with the  
13 electronic component to be cooled – Koga's sucking channel 19 and transverse section 30 *are* in  
14 thermal contact with the heat generating component 2. Again, Dr. Tilton implicitly admits that  
15 Koga discloses the remaining limitations of claim 10.

16 Dr. Tilton relies on the fact that claims 11-14 depend from claim 10 as the reason why  
17 claims 11-14 are not anticipated or rendered obvious by Koga. By relying solely on dependence  
18 from claim 10, Dr. Tilton implicitly admits that the remaining limitations of claims 11-14 are  
19 anticipated or rendered obvious by Koga.

20 As for claim 15, Dr. Tilton states that the following limitation of the '764 Patent is not  
21 disclosed or suggested by Koga: "a reservoir including an impeller cover, an intermediate  
22 member and a heat exchange interface, wherein a top wall of the reservoir and the impeller cover  
23 define a pump chamber for housing the impeller, and the intermediate member and the heat  
24 exchange interface define a thermal exchange chamber, the pump chamber and the thermal  
25 exchange chamber being spaced apart from each other in a vertical direction and fluidly coupled  
26 together." Tilton Validity Report at 32. Dr. Tilton based this faulty assertion on the idea that  
27 Koga allegedly does not disclose a "pump chamber" that is separate from the "thermal exchange  
28 chamber." However, as discussed above in reference to claim 10, Koga's sucking channel and



transverse section function as a separate “thermal exchange chamber,” meaning that Koga anticipates or renders obvious claim 15.

Dr. Tilton relies on the fact that claims 16-18 depend from claim 10 as the reason why claims 16-18 are not anticipated or rendered obvious by Koga. By relying solely on dependence from claim 10, Dr. Tilton implicitly admits that the remaining limitations of claims 16-18 are anticipated or rendered obvious by Koga.

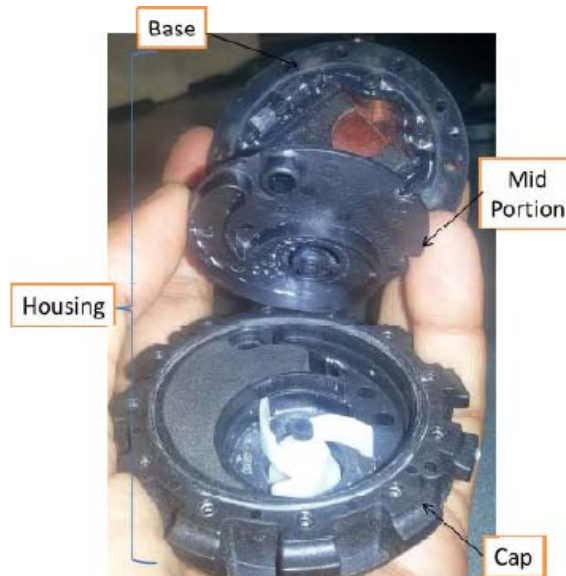
### **VIII. ASETEK’S GEN III AND GEN IV PRODUCTS INFRINGE THE COOLIT PATENT**

As detailed in the Pokharna Infringement Report, both Asetek’s Gen III and Gen IV products infringe claims 17-19 of the CoolIT patent. Dr. Pokharna identifies how each accused product includes each limitation of each of the asserted claims. *See generally id.* at 7-90. In arguing against infringement, Asetek’s expert only disputes one limitation (“a mid-portion positioned between and mechanically coupled with the cap and the base member”) of these claims with regard to the Gen III products and two limitations (“a cap defining a recess at least partially defining the reservoir” and “a port” in the housing wall) with regard to the Gen IV products. Expert Report of Dr. Donald E. Tilton Regarding Non-Infringement of U.S. Patent No. 8,382,456 (“Tilton Non-Infringement Report”), attached as Ex. N to Dion Decl. Thus, it is undisputed that the accused products meet all but these three limitations. At his deposition, however, Dr. Tilton implicitly or explicitly conceded that these elements are met also.

#### **A. Asetek’s Gen III Products Have “a Mid-Portion Positioned Between and Mechanically Coupled with the Cap and the Base Member”**

Asetek’s Gen III products include a mid-portion, a cap, and a base member. As identified by Dr. Pokharna in the following picture, these are the upper cover to the cooling head, the intermediate cover that encloses the impeller chamber and reservoir, and the base of the cooling head, which includes the cold plate:





Pokharna Infringement Report at 61.

Dr. Tilton agrees. *See* Tilton Non-Infringement Report at p. 19, ¶64. Dr. Tilton’s only argument against infringement is that “The impeller cover is not connected at all to the thermal exchange interface (the alleged ‘base member’).” *Id.* As can be readily seen from the picture, the “mid-portion” is press fit into the “cap,” and then the “base” is screwed to the “cap”. When the “base” is screwed to the “cap,” it necessarily creates a mechanical coupling between the “base” and the “mid-portion”. Dr. Tilton agrees that the “base” is “in mechanical contact” with the “mid-portion,” Tilton Tr. at 159:13-161:16.<sup>6</sup> Nonetheless, Dr. Tilton disputes that the “mid-portion” and the “base” are “mechanically coupled”. *Id.* at 164:5-21. Dr. Tilton’s position, in view of his admission that the two parts are in mechanical contact is not tenable. Accordingly, Asetek’s Gen III products infringe claims 17-19 of the CoolIT patent.

#### **B. Asetek’s Gen IV Products Have “a Cap Defining a Recess at Least Partially Defining the Reservoir”**

In his report, Dr. Tilton argues that the Asetek Gen IV products lack the requisite “recess” simply because the cap has no recess at all. Tilton Non-Infringement Report at p. 30, ¶108 (“As described earlier with regard to claim 16, the alleged ‘cap’ has a flat inner wall *with no recess*

<sup>6</sup> The discussion here relates to claim 12, but Dr. Tilton notes in his report that his position with regard to this issue is the same for both claim 12 and claim 17. *See* Tilton Non-Infringement Report at p. 19, ¶64.

1 *thereon.*”) (emphasis added). Yet again, when pressed on this issue at his deposition, Dr. Tilton was  
 2 forced to concede that the cap does, indeed, have a recess. Tilton Tr. at 180:10-190:3. Ultimately,  
 3 Dr. Tilton testified:

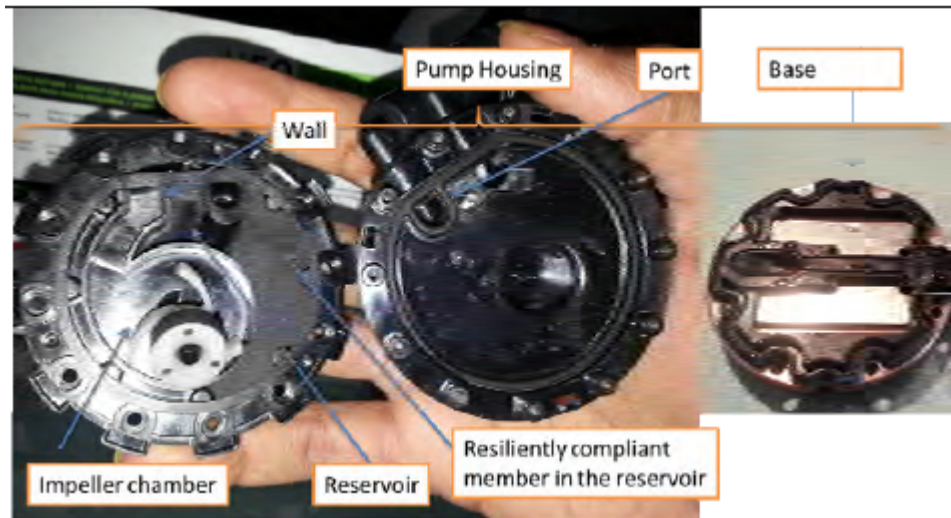
4 Q. So, would you agree that there is a recess in the cap where – and  
 5 that the entire flat surface what we discussed sits in the recess?

6 A. That, I guess, is true. The recess – that entire flat surface is very  
 7 slightly below the lip that holds the O-ring in place.

8 *Id.* at 189:8-13.

### 9 C. Asetek’s Gen IV Products Have a “Port”

10 Claim 17 of the CoolIT patent requires, *inter alia*, an impeller chamber and a reservoir,  
 11 which are separated “by a housing wall defining a port configured to fluidically couple the impeller  
 12 chamber and the reservoir...” CoolIT Patent at claim 17. The Asetek Gen IV products, while  
 13 lacking a port formed directly in the wall, have a “port” that is formed by a recess in the cap that  
 14 allows fluid to flow over the top of the wall, as seen here:



15 Pokharna Infringement Report at 83. This port is defined, at least in part, by the housing wall.  
 16 Even if the port is not literally present this limitation is satisfied under the doctrine of equivalents.

17 “To find infringement under the doctrine of equivalents, any differences between the  
 18 claimed invention and the accused product must be insubstantial. One way of proving  
 19 infringement under the doctrine of equivalents is to show, for each claim limitation, that the  
 20 accused product performs substantially the same function in substantially the same way with  
 21 substantially the same result as each claim limitation of the patented product.” *Brilliant*

*Instruments, Inc. v. GuideTech, LLC*, 707 F.3d 1342, 1346-1347 (Fed. Cir. 2013) (quotations and citations omitted). Here, claim 17 explicitly states that the function of the port is to “fluidically couple” the impeller chamber and the reservoir, a function that is undoubtedly performed by the recess in the cap of the Gen IV product. *See* Tilton Tr. at 175:20-176:15. Moreover, the way in which this fluidic coupling is accomplished (an opening between the two areas) and also the result (fluid coupling of the impeller chamber and reservoir) are substantially the same. In disputing infringement of this element of claim 17, Dr. Tilton relied on flow path limitations from claim 1 that are simply not present in claim 17. *Id.* at 177:21-180:9. Because the limitations relating to the flow path in claim 1 are not present in claim 17, this argument is irrelevant. Accordingly, there are no disputes of material fact that Asetek infringes claims 17-19 of the CoolIT patent.

#### **IX. ASETEK CANNOT SHOW WILLFUL INFRINGEMENT OF THE ASETEK PATENTS**

Because Asetek cannot establish infringement of the Asetek patents, its claim for willful infringement necessarily fails. But even if a genuine issue of material fact existed on the issue of infringement of the Asetek patents (which it does not), the Court should dispose of Asetek’s baseless willful infringement claim on summary judgment because, at every relevant time period, CoolIT had clear, legitimate, and objectively reasonable defenses to Asetek’s claims.

The Federal Circuit has held that a showing of willful infringement requires that the plaintiff establish by clear and convincing evidence (1) that the accused infringer “acted despite an objectively high likelihood that its actions constituted infringement of a valid patent,” and (2) that this objectively defined risk “was either known or so obvious that it should have been known to the accused infringer.” *In re Seagate Tech., LLC*, 497 F.3d 1360, 1371 (Fed. Cir. 2007) (*en banc*).

The evidence affirmatively establishes that Asetek cannot establish willful infringement. Under the objective prong of the willful infringement analysis, “a patentee must show by clear and convincing evidence that the infringer acted despite an objectively high likelihood that its actions constituted infringement of a valid patent.” *In re Seagate Tech., LLC*, 497 F.3d at 1371. “The state of mind of the accused infringer is not relevant to this objective inquiry.” *Id.* This

1 objective determination entails an assessment of the reasonableness of the accused infringer's  
 2 defenses, such as its arguments about non-infringement. *See Bard Peripheral Vascular, Inc. v.*  
 3 *W.L. Gore & Assocs., Inc.*, 682 F.3d 1003, 1006 (Fed. Cir. 2012).

4 The Federal Circuit recently made clear that this objective prong presents a legal question  
 5 suitable for summary judgment. “When a defense or noninfringement theory asserted by an  
 6 infringer is purely legal (*e.g.*, claim construction), the objective recklessness of such a theory is a  
 7 purely legal question to be determined by the judge.” *Id.* at 1007. Even in those instances when  
 8 the objective prong turns on factual issues, “the judge remains the final arbiter of whether the  
 9 defense was reasonable, even when the underlying fact question is sent to a jury.” *Id.*

10 Asetek’s willful infringement claim fails as a matter of law under the objective prong  
 11 because CoolIT has reasonable non-infringement and invalidity defenses. As explained above,  
 12 CoolIT has, and has had since the patent issued, clear non-infringement arguments. In addition,  
 13 CoolIT has a reasonable argument regarding the invalidity of the Asetek patents. In fact, all  
 14 claims of the ‘764 patent have been rejected by the USPTO in an action closing prosecution in a  
 15 pending reexamination.

16 Because CoolIT’s non-infringement and invalidity defenses are and always have been  
 17 objectively reasonable—in fact, more than sufficient to warrant summary judgment—Asetek’s  
 18 entire willful infringement claim fails. *See Bard Peripheral Vascular, Inc.*, 682 F.3d at 1006  
 19 (satisfying objective prong is a “threshold determination” for a finding of willfulness).

## 20 **X. CONCLUSION**

21 CoolIT’s accused products do not infringe the ‘362 and ‘764 patents. Even if they did,  
 22 CoolIT is not liable to Asetek for its sales to Corsair, since those sales occur outside the U.S. In  
 23 addition, Asetek’s claim for lost profits does not meet the standard articulated in *Panduit*, so  
 24 Asetek, at most, would be entitled only to a reasonable royalty if this Court were to hold that  
 25 CoolIT’s products infringe Asetek’s patents at issue. Notwithstanding CoolIT’s non-  
 26 infringement, Asetek’s ‘764 Patent is invalid under 35 U.S.C. §§ 102 and 103 because claims 1-  
 27 19 are anticipated by or are obvious from U.S. Patent No. 7,544,049 to Koga. Finally, it is  
 28 undisputed that Asetek infringes claims 17-19 of the CoolIT patent.

1 Accordingly, and for the reasons stated herein, CoolIT respectfully requests that the Court  
2 enter summary judgment in CoolIT's favor of (1) non-infringement of Asetek's U.S. Pat. Nos.  
3 8,240,362 and 8,245,764 for all accused products; (2) no damages for all sales made by CoolIT  
4 outside of the U.S.; (3) no lost profits damages; (4) invalidity of U.S. Pat. No. 8,245,764; and (5)  
5 infringement by Asetek's Gen III and Gen IV products of CoolIT's U.S. Pat. No. 8,382,456.

6 Dated: June 19, 2014

BLANK ROME LLP  
DENNIS P. MCCOOE  
JOEL L. DION

9 /s/ Joel L. Dion

10 JOEL L. DION  
11 Attorneys for Defendant  
COOLIT SYSTEMS INC.

**CERTIFICATE OF SERVICE**

The undersigned certifies that, on June 19, 2014 I caused a copy of the foregoing  
DEFENDANT COOLIT SYSTEMS, INC.'S NOTICE OF MOTION AND MOTION FOR  
SUMMARY JUDGMENT OF NON-INFRINGEMENT OF U.S. PAT. NOS. 8,240,362 AND  
8,245,764, NO DAMAGES FOR NON-U.S. SALES, NO LOST PROFITS, INVALIDITY OF  
U.S. PAT. NO. 8,245,764, AND INFRINGEMENT OF U.S. PAT. NO. 8,382,456 to be filed with  
the Court via ECF and served electronically thereby on the following counsel of record:

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